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A dynamic sulfur-rich network from silicone industry waste

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Industrial waste accumulation poses significant environmental challenges. Dimethyldivinylsilane, a notable side product of the silicone industry, is left without a specific use. Meanwhile, sulfur, the most common byproduct of the petrochemical industry, is frequently in surplus despite being largely utilized for sulfuric acid production. This study employed the inverse vulcanization technique to upcycle these two waste streams into sulfur-rich dynamic polymer networks. The silicon-based crosslinker contributed to distinct dynamic behaviors for the synthesized polymers compared to other inverse vulcanized networks, resulting in a variety of accessible morphologies depending on specific processes. The produced sulfur-rich malleable film was found to enhance the high-temperature performance of monolayer MoS₂ transistors by healing the sulfur vacancies and suppressing the switching hysteresis. This investigation highlights the potential for industrial waste upcycling and its application in the future design of materials and devices.

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1. Our work transforms two major industrial waste streams (dimethyldivinylsilane and sulfur) into a high-value functional material using solvent-free inverse vulcanization.
2. We achieved atom-efficient conversion of low-value waste into a dynamic polymer. Applied as a coating, it extends the lifespan of monolayer MoS₂ transistors as a candidate for next generation electronics by healing defects.
3. Further research will focus on low-energy, scalable synthesis, exploring diverse applications, and enabling closed-loop material recycling after end-of-life.

Introduction

Recently, the emphasis on sustainable development has heightened the need for efficient recycling of industrial byproducts. In this context, two industrial wastes, dimethyldivinylsilane (DMDVS) and sulfur, are considered here. DMDVS is an inevitable side-product in the production of 1,1,3,3-tetramethyl-1,3-divinylsiloxane (DVS) through the Wurtz–Fittig process (Fig. 1a).^{1–4} Silicon, the second most abundant element in the Earth's upper continental crust,⁵ underpins a well-developed silicon industry, in which DVS serves as a critical raw material; notably, it also serves as the ligand in Karstedt's catalyst for hydrosilylation, one of the largest-scale applications of homogeneous catalysis.^{6,7} The global DVS production is consistently growing driven by continuous advancements in

sectors such as coatings, adhesives, sealants, and electronic materials. However, at present, its side product DMDVS does not have any specific industrial application, resulting in long-term storage and the risk of atmospheric release. On the other hand, sulfur has a high abundance on Earth, making it the 16th most abundant in the Earth's upper continental crust,^{5,8} predominantly occurring as sulfide and sulfate minerals. Sulfur holds significant value in industry, agriculture, and materials science.^{9–11} Meanwhile, elemental sulfur today is mostly derived as a byproduct from the petrochemical industry during the sulfur removal processes from crude oil and natural gas.^{12,13} In 2021 alone, over 81 million tons of sulfur were produced across the globe,¹⁴ surpassing its consumption in the production of sulfuric acid, fertilizers, and fungicides. The excess sulfur, stored as powder or bricks outdoors, presents potential environmental challenges that have yet to be fully addressed.^{8,14–16}

Pyun and coworkers¹⁷ pioneered inverse vulcanization, a method to utilize these two abundant low-value chemicals. Inverse vulcanization is a solvent-free reaction that produces a sulfur-rich functional polymer by radical polymerization between unsaturated organic crosslinkers and sulfur. Sulfur

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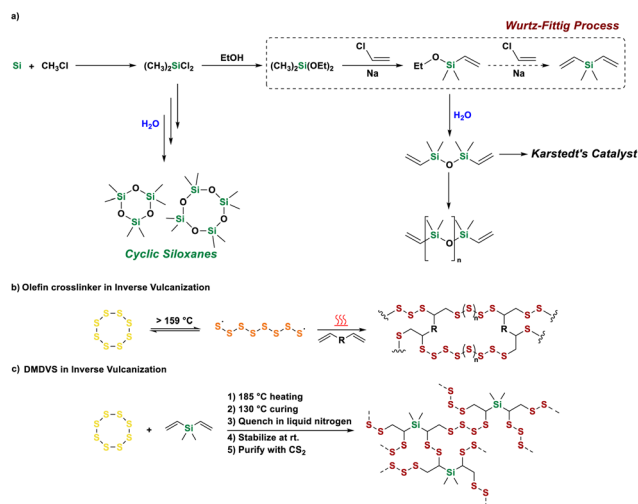


Fig. 1 Overview of DMDVS and its inverse vulcanization. (a) Production of siloxanes and DVDSi in the silicone industry. (b) A general scheme of inverse vulcanization, where R indicates the core of small-molecule crosslinkers. (c) Proposed structure of poly(DMDVS-*r*-S) and key steps toward it.

melts and undergoes ring-opening to produce chain-end radicals over 159 °C that add to crosslinkers (Fig. 1b).¹⁸ Since then, notable progress has been made in both the inverse vulcanization procedure and the applications of these unique sulfur-rich functional polymers. The range of organic crosslinkers explored for inverse vulcanization has expanded from synthetic feedstocks, such as 1,3-diisopropenylbenzene^{17,19,20} and divinylbenzene,^{21,22} to silicon-containing crosslinkers such as styrylethyltrimethoxysilane²³ and high-modulus re-graphic silicone,²⁴ to bio-based resources such as limonene,²⁵ vegetable oils,^{26,27} thiocetic acid and its derivatives.^{28,29} Currently, the primary methods for inverse vulcanization include heat activation,^{17,30} diethyldithiocarbamate catalysis,³⁰ mechanochemical activation,³¹ chemical vapor deposition,^{32,33} photoactivation,³⁴ and anionic methods.^{35,36} Beyond inverse

vulcanization, several novel approaches for sulfur valorization have emerged. Pyun and co-workers have employed sulfenyl chlorides to synthesize disulfide-linked polymers.³⁷ Chalker and co-workers introduced trisulfide electrochemical and photochemical initiation strategies for the preparation of poly(trisulfide) materials.^{38–40} These sulfur-rich functional polymers can be utilized in various fields such as infrared optics,^{11,19,20,40–44} antibacterial surfaces,^{45–48} pollution remediation,^{25,31,47,49–51} precious metal acquisition,^{30,39,52} lithium-sulfur batteries,^{8,11,53–56} bitumen-like materials,⁵⁷ high-refractive-index coatings,^{32,58} and pressure-sensitive adhesives.^{18,28,59,60}

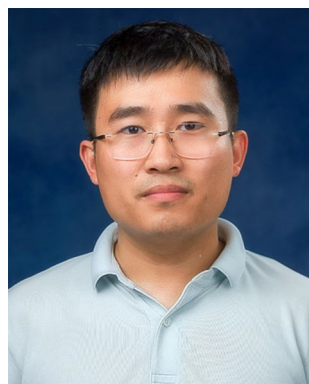
Herein, we report a new sulfur-rich dynamic polymer network produced by inverse vulcanization of DMDVS, effectively upcycling these low-value industrial side streams into an advanced functional material with unprecedented thermo-responsive behavior. Unlike conventional inverse vulcanized networks, our polymer network exhibits unique dynamic behavior enabled by the distinctive molecular architecture of DMDVS, including extended polysulfide domains stabilized by the Si-based framework and temperature-dependent phase transitions. While being a viscous liquid at elevated temperature, it can be trapped in a gel state by rapid quenching. The network becomes unstable at room temperature with spontaneous elemental sulfur segregation through a solid-solid transition. Upon removal of the elemental sulfur, it transforms into a denser yet fully reprocessable elastomer. Remarkably, the resulting sulfur-rich film, serving as a packaging material, can improve the high-temperature performance of monolayer MoS₂ transistors by inhibiting sulfur vacancies in the latter.

Results and discussion

Material preparation

Based on previous studies,^{57,61–64} we establish an optimized procedure for DMDVS inverse vulcanization, consisting of five key steps as depicted in Fig. 1c: (1) 185 °C reaction, (2) curing at 130 °C, (3) liquid nitrogen quenching, (4) room-temperature stabilization, and (5) CS₂ (toxic) extraction. As demonstrated in a prior work,¹⁷ effective inverse vulcanization requires homogeneously blending molten sulfur and a nonvolatile divinyl crosslinker at an elevated temperature to open S₈ rings and facilitate sulfur radical addition to vinyl groups.⁶⁵ However, DMDVS, with a low boiling point of 82 °C, is immiscible with molten sulfur due to its rapid vaporization at >100 °C. To overcome this challenge, we used a sealed tall vial (Fig. S1) as a disposable reactor and condenser to house the reactants throughout the reaction.

The appearance of the mixture evolved throughout the reaction. It turned into a low viscosity orange liquid when initially heated to 185 °C, as shown in Fig. S2. After staying at 185 °C for 1 h, the system transformed into a pomegranate-red liquid with an increased viscosity. A curing step at 130 °C was implemented to allow thorough exchange and formation of the networks.⁶¹ After the temperature was maintained at



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We examined the Si contents and glass transition temperatures (T_g) of these polymers prepared under different conditions (Table 1) by inductively coupled plasma optical emission spectrometry (ICP-OES) and differential scanning calorimetry (DSC) to preliminarily understand their composition. Interestingly, ICP-OES results revealed that poly(DMDVS_{1-r}-S₀) contained a greater Si content than samples with a smaller or larger DMDVS feed. It was found that the silicon content has a negative correlation with reaction time but a positive correlation with curing time. Thus, the former contributed more to the evaporation as the latter helped with the incorporation.

Fig. 2 Structural characterization of DMDVS-based inverse vulcanization polymers. (a) PXRD patterns of different poly(DMDVS_{1-r}-S₉) samples. (b) FT-IR spectra of poly(DMDVS_{1-r}-S₉) samples compared to DMDVS. (c) DSC curves. (d) ¹³C solid-state NMR of poly(DMDVS_{1-r}-S₉)-S. (e) Full XPS surveys and deconvoluting spectra of S 2p.

Polymer ^a	$m_0(\text{DMDVS}) : m_0(\text{S}_8)$ (wt% : wt%)	Heating time (h)	Curing time (h)	Si content ^b (wt%)	$T_{\text{g, DSC}}$ ^c (°C)
Poly(DMDVS _{1.5} - <i>r</i> -S _{8.5})-S	15 : 85	1	45	0.669 ± 0.051	125.4
Poly(DMDVS ₁ - <i>r</i> -S ₉)-S	10 : 90	1	45	2.63 ± 0.21	127.4
Poly(DMDVS _{0.5} - <i>r</i> -S _{9.5})-S	5 : 95	1	45	0.440 ± 0.023	114.0
Poly(DMDVS ₁ - <i>r</i> -S ₉)-S	10 : 90	1	0	1.26 ± 0.35	134.2
Poly(DMDVS ₁ - <i>r</i> -S ₉)-S	10 : 90	1	24	2.21 ± 0.33	129.8
Poly(DMDVS ₁ - <i>r</i> -S ₉)-S	10 : 90	2	0	1.22 ± 0.13	134.2
Poly(DMDVS ₁ - <i>r</i> -S ₉)-S	10 : 90	2	24	1.91 ± 0.18	131.0
Poly(DMDVS ₁ - <i>r</i> -S ₉)-S	10 : 90	2	45	2.19 ± 0.23	124.8
Poly(DMDVS ₁ - <i>r</i> -S ₉)-S	10 : 90	3	0	1.15 ± 0.09	132.9
Poly(DMDVS ₁ - <i>r</i> -S ₉)-S	10 : 90	3	24	1.59 ± 0.18	128.8
Poly(DMDVS ₁ - <i>r</i> -S ₉)-S	10 : 90	3	45	1.70 ± 0.12	128.4

^a Reaction conditions: a 5 min quenching is applied after curing. ^b Average weight ratio (wt%) of silicon is determined by ICP-OES in 4 parallel tests, errors are the standard deviation of 4 samples and original data can be found in Table S1. ^c Extracted from the third cycle of DSC curves of each polymer. Full curves are available in Fig. S5.

the results in Table 1 into account, we selected poly(DMDVS₁-*r*-S₉)-S from the second row with a 1-h reaction followed by 45 h of curing for the subsequent studies.

Material characterization

In an unexpected turn of events, our powder X-ray diffraction (PXRD) examination of the solids revealed a pattern of poly(DMDVS₁-*r*-S₉)-S closely aligned with that of S₈ (Fig. 2a). This finding contradicted our earlier verdict that poly(DMDVS_{*x*}-*r*-S_{*y*}) differs from sulfur. Simultaneously, poly(DMDVS₁-*r*-S₉)-G did not exhibit any discernible PXRD peak. This suggests that the sulfur signals in poly(DMDVS₁-*r*-S₉)-S did not originate as a residue of the reactant. Instead, they were a result of transformations from poly(DMDVS₁-*r*-S₉)-G when warmed to room temperature. Consequently, we postulate that a dynamic network with metastable long sulfur chains or rings was formed during the curing process, which was kinetically trapped by rapid quenching (Fig. 3a). As the temperature increased to ambient conditions, added thermal energy induced scission of the extended polysulfide chains, resulting in the formation of S₈ rings.

To verify that hypothesis, we first stored poly(DMDVS₁-*r*-S₉)-G at -20 °C for over 6 months, observing no state change (Fig. S6). This proves that the transformation toward poly(DMDVS₁-*r*-S₉)-S does need a sufficient energy input. As described above, the glass transition of poly(DMDVS_{*x*}-*r*-S_{*y*})-S was measured by DSC (Table 1 and Fig. S5) to provide evidence of its distinction from sulfur. However, pairs of apparent endothermic peaks related to the elemental sulfur were observed only in the first DSC cycles of all poly(DMDVS_{*x*}-*r*-S_{*y*})-S samples. For poly(DMDVS_{*x*}-*r*-S_{*y*})-S samples without curing, a new melting peak slightly lower than the original pair was observed in the second DSC cycle, indicating a less crystalline species related to the reactant. During the subsequent cycles, only glass transitions were detectable (Fig. 2c and Fig. S5). This means that although elemental sulfur did exist in poly

(DMDVS_{*x*}-*r*-S_{*y*})-S, the rate of its formation did not keep pace with the fast 10 °C min⁻¹ heating/cooling in the ensuing cycles. Hence, the rapid heating/cooling in DSC essentially reversed the transformation from poly(DMDVS_{*x*}-*r*-S_{*y*})-G to poly(DMDVS_{*x*}-*r*-S_{*y*})-S. Based on these experiments, we can firmly conclude that poly(DMDVS_{*x*}-*r*-S_{*y*})-S is a polymer network, wherein S₈ originates from rearrangement of longer sulfur chains.

With that in mind, we tried to extract elemental sulfur and any soluble molecules from poly(DMDVS₁-*r*-S₉)-S (Fig. S7). However, all detected proton signals in the extracts were from the solvents implying the absence of soluble organic molecules. On the other hand, CS₂, with its exceptional ability to dissolve elemental sulfur, was able to remove all S₈ molecules to yield a dark red elastomer, poly(DMDVS₁-*r*-S₉)-E (Fig. S3), as evidenced by PXRD (Fig. 2a). Poly(DMDVS₁-*r*-S₉)-E had a slightly lower *T*_g (124.6 °C) than poly(DMDVS₁-*r*-S₉)-S (Fig. 2c), indicating similar segment mobility. Meanwhile, it no longer had sulfur melting peaks in the first cycle (Fig. S5). Without any structural information from the extracts, we instead turn to solid-state ¹³C nuclear magnetic resonance (NMR) and X-ray photoelectron spectroscopy (XPS) to gain an insight into the structure. We observed a sharp Si-C peak at ~0 ppm and a few broad S-C peaks between 10 and 60 ppm (Fig. 2d). Interestingly, a broad but weak vinyl bump at 130 ppm was also present. Poly(DMDVS₁-*r*-S₉)-E showed almost identical ¹³C NMR features (Fig. S8) but the Si-C peak splits into two. This is likely a result of improved resolution after S₈ removal. We observed characteristic XPS peaks of S 2s, S 2p, Si 2s, and Si 2p in both poly(DMDVS₁-*r*-S₉)-S and poly(DMDVS₁-*r*-S₉)-E (Fig. 2e). The reduced intensity of sulfur peaks in the full XPS surveys of poly(DMDVS₁-*r*-S₉)-E further confirmed the removal of crystalline sulfur. Assuming that each C=C bond formed two C-S bonds, we were able to determine the sulfur rank (SR)³³ of poly(DMDVS₁-*r*-S₉)-S based on eqn (1) derived in the SI and the silicon content measured by ICP-OES (Table 1).

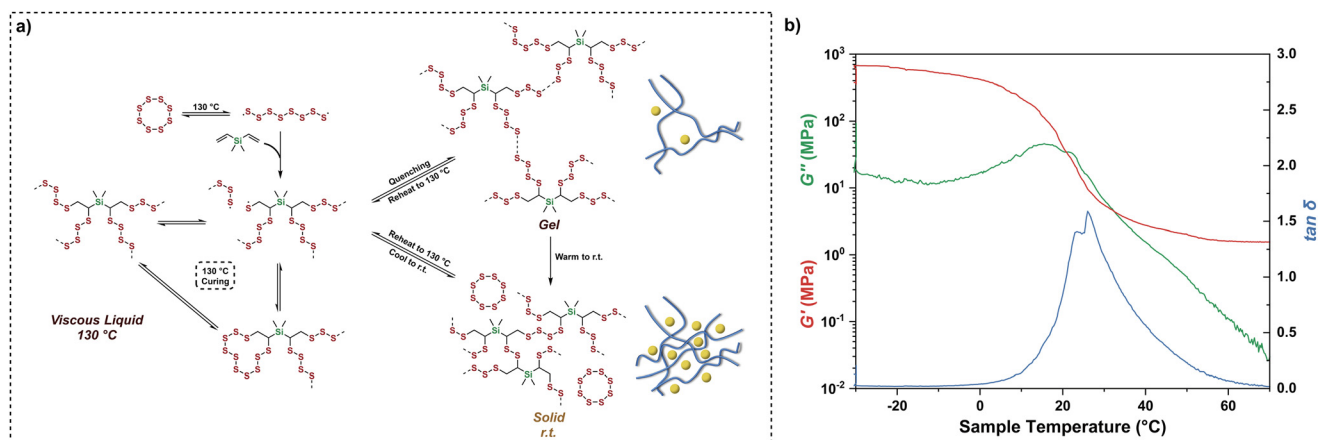


Fig. 3 Mechanical studies of poly(DMDVS₁-*r*-S₉)-G and proposed mechanisms. (a) The proposed mechanism of the reaction between DMDVS and S₈ and the formation of different types of poly(DMDVS_{*x*}-*r*-S_{*y*}). (b) DMA of poly(DMDVS₁-*r*-S₉)-F. The specimen was cut into 8.0 mm × 35 mm × 0.10 mm (width × length × thickness).



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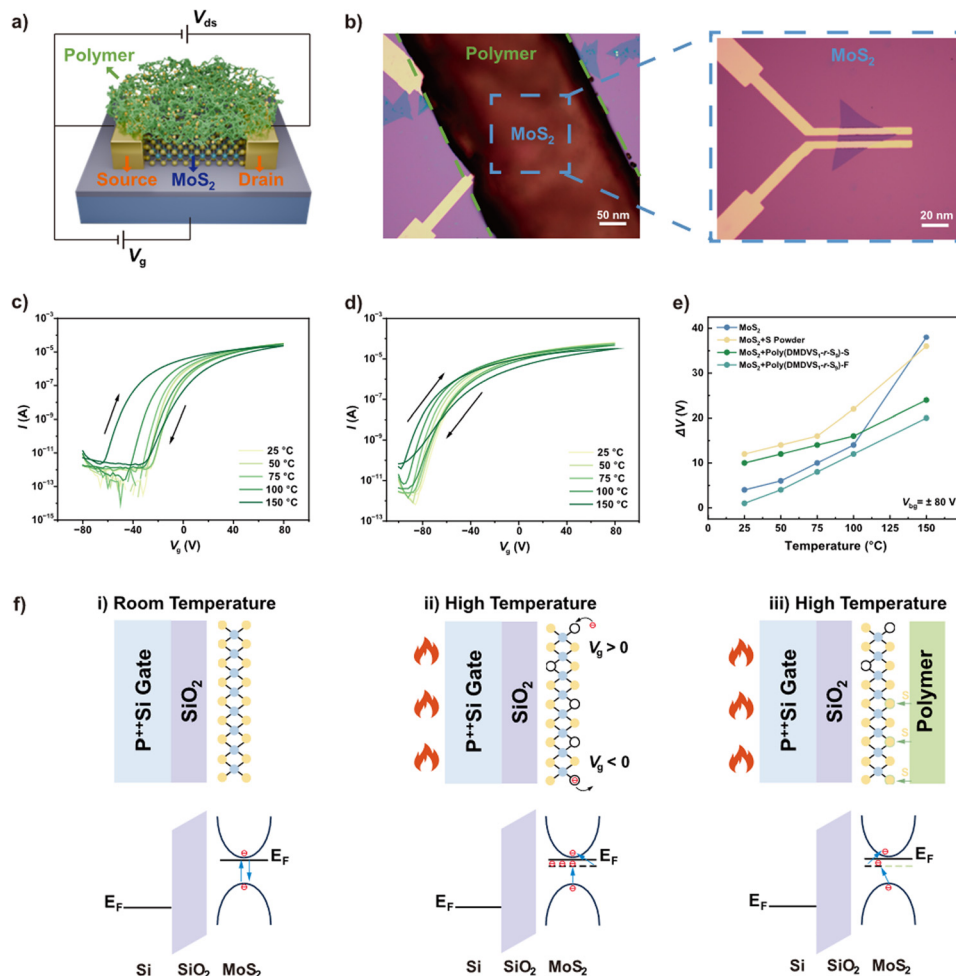


Fig. 4 Electrical characteristics of the MoS₂/poly(DMDVS₁-*r*-S₉)-F device. (a) Scheme and (b) optical micrograph of the MoS₂/poly(DMDVS₁-*r*-S₉)-F device. MoS₂ and poly(DMDVS₁-*r*-S₉)-F were outlined by the blue and green dashed lines, respectively. Transfer curves of the MoS₂ FETs (c) without and (d) with poly(DMDVS₁-*r*-S₉)-F measured across varying temperatures under vacuum. V_g from -100 to 80 V back and forth at V_{ds} = 1 V. (e) Extracted hysteresis window as a function of temperature incorporating various sulfur-containing materials. (f) Proposed mechanisms for hysteresis alongside the corresponding band diagrams: thermally activated SVs act as electron trapping/de-trapping centers in MoS₂, whereas sulfur moieties in the polymer partially passivate these SVs, thereby suppressing the hysteresis window at elevated temperatures.

sulfur-containing moieties that coordinate with under-coordinated Mo atoms at the MoS₂ interface (Fig. 4F(iii)). This dynamic passivation process suppresses SV formation below a critical threshold, stabilizing the hysteresis window and sub-threshold swing. This approach hence unlocks the application potential of two-dimensional sulfide materials in high-temperature electronics, harnessing the sustained sulfur release property of the dynamic sulfur-rich network.

Conclusions

In summary, this work has demonstrated a waste-to-value transformation of sulfur-rich dynamic polymer networks from the combination of two considerable forms of industrial waste: dimethyldivinylsilane and elemental sulfur. Elevated temperatures prompt the S₈ ring to open, resulting in radical polymerization in a viscous fluid that solidifies upon cooling, forming

an elastic gel when the liquid mixture is rapidly quenched in liquid nitrogen and stored at low temperatures. Warming this gel triggers decomposition that leaves behind elemental sulfur and a denser network. Following the removal of such elemental sulfur, the residual sulfur-rich network can be molded into films, showing potential as a protective coating for monolayer MoS₂ transistors. This coating as a sulfur reservoir significantly reduces the switching hysteresis of the device by 47% at 150 °C, thanks to the sustained sulfur release of the polymer that passivates the otherwise abundant sulfur vacancies in MoS₂. The inherent dual-vinyl functionalities of dimethyldivinylsilane endow it with immense potential in constructing functional polymers. This work plants the seed of possibility in transforming low-value industrial waste into functional materials for future advancements, thereby advocating for an increased focus on the value-added applications of waste chemicals. We envision this study opening another path towards achieving sustainability.



Author contributions

Conceptualization, J. Y., Q. J., and Z. W.; methodology, Z. W., J. Y., Q. J., Y. L., and Y. Q.; validation, J. Y., Q. J., and Z. W.; formal analysis, Z. W., J. Y., Y. Q., and Q. J.; investigation, Z. W., Y. Q., Z. C., H. H., Y. S., X. L., Y. Y., and Y. L.; resources, J. Y. and Q. J.; data curation, Z. W., Y. Q., J. Y., and Q. J.; writing – original draft, Z. W., J. Y., and Y. Q.; writing – review & editing, J. Y. and Q. J.; visualization, Z. W., Y. Q., and Y. S.; supervision, J. Y., Q. J., and H. Z.; project administration, J. Y., Q. J., and H. Z.; and funding acquisition, J. Y., Q. J., H. Z., and H. H.

Conflicts of interest

Part of the results have been filed in a patent (CN118930861B) by ShanghaiTech University with J. Y., Z. W., and Z. C. as inventors. Zhejiang Jiancheng New Materials Co., Ltd, a material donor, may potentially benefit from the findings.

Data availability

The data supporting the findings of this study are available from the corresponding author upon reasonable request.

Supplementary information (SI): all experimental data, including experimental methods, raw measurements, characterization results and calculations. See DOI: <https://doi.org/10.1039/d5gc02864g>.

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